

SE-1206T-YGC

PACKAGE DIMENSION

◇ **Package Dimensions of Device**

UNIT: mm

◇ **Tape Specification: 3,000pcs per reel**

Packing Size													
Item	W	P1	E	F	D	D1	Po	10Po	P2	Ao	Bo	Ko	t
Spec.	8.00	4.00	1.75	3.50	1.55	1.0	4.00	40.00	2.00	1.78	3.40	1.04	0.229
Tolerance	±0.20	±0.10	±0.10	±0.05	±0.05	+0.25	±0.1	±0.20	±0.05	±0.10	±0.10	±0.10	±0.013

◇ **Package Dimensions of Reel**

◇ **Recommended Soldering Pad Dimensions**

NOTES:

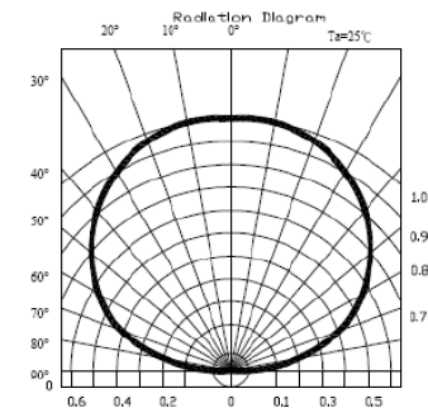
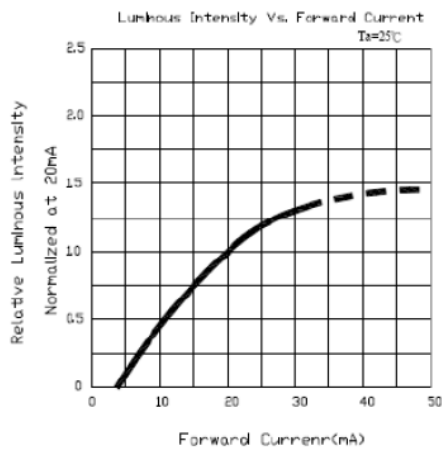
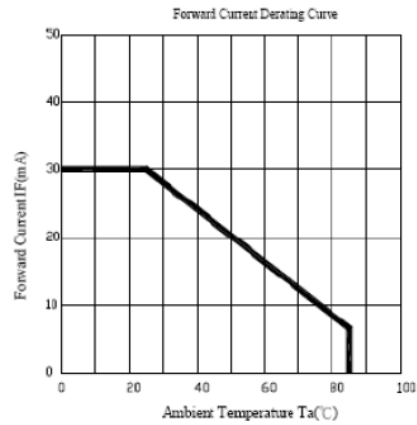
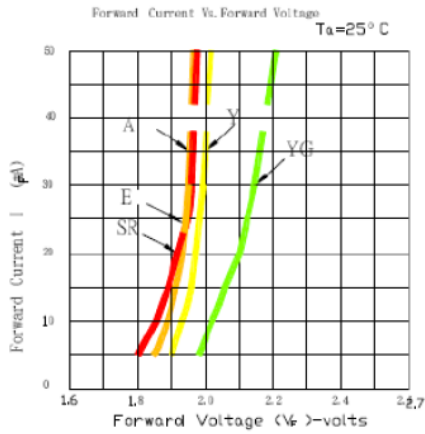
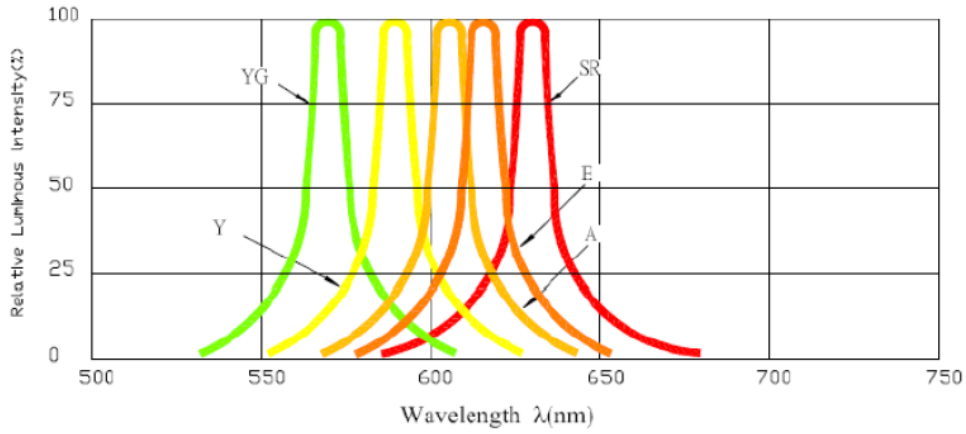
- All dimensions are in millimeter(inch);
- Tolerance is ±0.1mm(0.004") especially other specified;
- Specifications are subject to change without notice.

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<p>◇ Features:</p> <ul style="list-style-type: none"> ➤ Dice Material: GaP ➤ Light Color: Yellow Green ➤ Lens Color: Water Clear ➤ Package in 8mm tape on 7" diameter reel ➤ Compatible with automatic placement equipment ➤ Compatible with reflow solder process 	<p>◇ Applications:</p> <ul style="list-style-type: none"> ➤ Automotive: backlighting in dashboard switch ➤ Indicators ➤ LCD Back-lights ➤ Illuminations 																																																	
<p>◇ Absolute Maximum Ratings(Ta=25°C)</p> <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Maximum</th> <th>Unit</th> </tr> </thead> <tbody> <tr> <td>Power Dissipation</td> <td>PD</td> <td>75</td> <td>mW</td> </tr> <tr> <td>Continuous Forward Current</td> <td>IFmax</td> <td>30</td> <td>mA</td> </tr> <tr> <td>Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width)</td> <td>IFP</td> <td>125</td> <td>mA</td> </tr> <tr> <td>Reverse Voltage</td> <td>VR</td> <td>5</td> <td>V</td> </tr> <tr> <td>Derating Linear From 25°C</td> <td></td> <td>0.3</td> <td>mA / °C</td> </tr> <tr> <td>Operating Temperature Range</td> <td>Topr</td> <td>-30 to +80</td> <td>°C</td> </tr> <tr> <td>Storage Temperature Range</td> <td>Tstg</td> <td>-40 to +90</td> <td>°C</td> </tr> </tbody> </table>		Item	Symbol	Maximum	Unit	Power Dissipation	PD	75	mW	Continuous Forward Current	IFmax	30	mA	Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width)	IFP	125	mA	Reverse Voltage	VR	5	V	Derating Linear From 25°C		0.3	mA / °C	Operating Temperature Range	Topr	-30 to +80	°C	Storage Temperature Range	Tstg	-40 to +90	°C																	
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✧ Typical Electro-Optical Characteristics Curves



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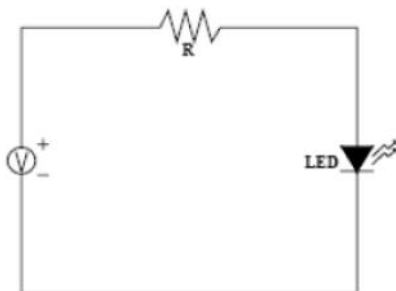
◇ **Descriptions**

- The Chip-LED Taping is much smaller than lead frame type components. Thus enable smaller board size, higher density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

◇ **Reliability Test Items And Conditions**

NO.	Item	Test Condition	Test Hr/cycle/time	Sample Q'ty
1	Solder Heat	TEMP:260°C±5°C	5sec	48pcs
2	Temperature Cycle	90°C~25°C~30°C~25°C 30m 5m 30m 5m	300 cycles	48pcs
3	Thermal Shock	100°C~55°C 10m 10m	100 cycles	48pcs
4	Operating Life	IF=20mA	1000 hrs	48pcs
5	High Temperature Storage	TEMP: +90°C	1000 hrs	48pcs
6	Low Temperature Storage	TEMP: -30°C	1000 hrs	48pcs
7	High Temperature	80°C	1000 hrs	48pcs
8	High Humidity	80%R.H.	1000 hrs	48pcs

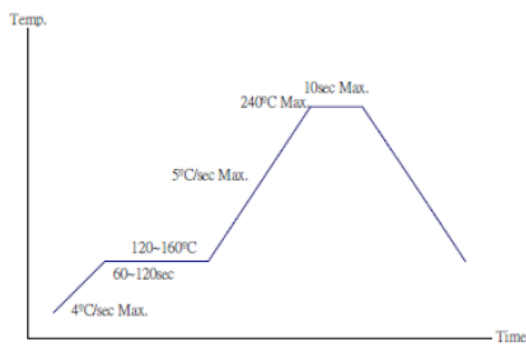
◇ **Test Circuit**



❖ **Precautions For Use**

- Overdrive current proof
Customer must apply resistors for protection; otherwise slight voltage shift will cause current change with great deal. (Burn out will happen)
- Storage
 - The operation of temperature and R.H. are: 5°C ~30°C, 60%R.H> Max.
 - Once the packing is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with desiccant. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
 - It's recommended to bake before soldering when the package is unsealed more than 72hrs. The condition is: 60°C±5°C for 15hrs.

❖ **Reflow Temp. / Time**



❖ **Hand Soldering Iron**

- Temperature at tip of iron: 400°C Max. (35W Max.)
- Soldering time: 3±1sec

❖ **Soldering Heat Reliability**

- Please refer to the following figure:

